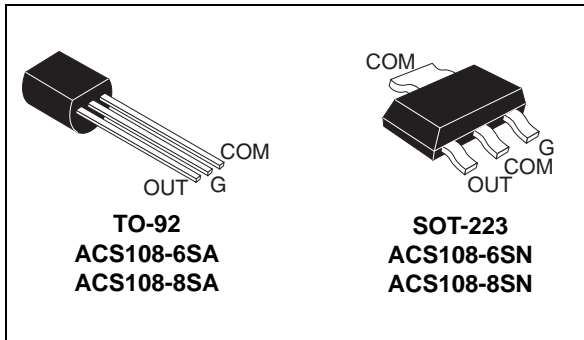


## Overvoltage protected AC switch (ACS™)

Datasheet - production data



### Description

The ACS108 belongs to the AC switch range (built with A. S. D.® technology). This high performance switch can control a load of up to 0.8 A. The ACS108 switch includes an overvoltage crowbar structure to absorb the inductive turn-off energy, and a gate level shifter driver to separate the digital controller from the main switch. It is triggered with a negative gate current flowing out of the gate pin.

### Features

- Enables equipment to meet IEC 61000-4-5 surge with overvoltage crowbar technology
- High noise immunity against static dV/dt and IEC 61000-4-4 burst
- Needs no external protection snubber or varistor
- Reduces component count by up to 80% and Interfaces directly with the micro-controller
- Common package tab connection supports connection of several alternating current switches on the same cooling pad
- $V_{CL}$  gives headroom before clamping then crowbar action

### Applications

- Alternating current on/off static switching in appliances and industrial control systems
- Driving low power high inductive or resistive loads like:
  - relay, valve, solenoid, dispenser,
  - pump, fan, low power motor, door lock
  - lamp

Figure 1. Functional diagram

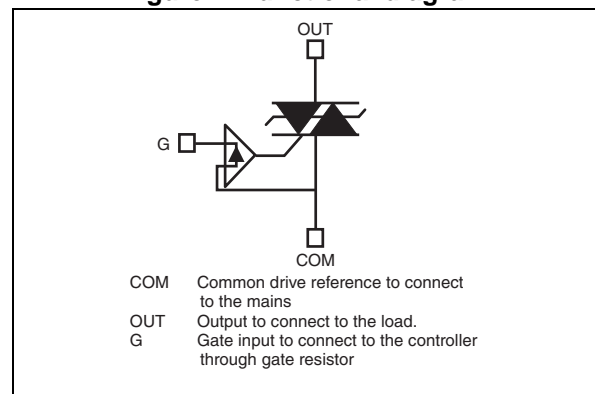


Table 1. Device summary

Symbol	Value	Unit
$I_{T(RMS)}$	0.8	A
$V_{DRM}, V_{RRM}$	600 and 800	V
$I_{GT}$	10	mA

®: A.S.D. is a registered trademark of STMicroelectronics

™: ACS is a trademark of STMicroelectronics

# 1 Characteristics

**Table 2. Absolute maximum ratings ( $T_{amb} = 25\text{ °C}$ , unless otherwise specified)**

Symbol	Parameter		Value	Unit	
$I_{T(RMS)}$	On-state rms current (full sine wave)	TO-92	$T_{amb} = 64\text{ °C}$	0.45	A
			$T_{lead} = 76\text{ °C}$	0.8	A
		SOT-223 $S = 5\text{ cm}^2$	$T_{amb} = 76\text{ °C}$		
			$T_{tab} = 104\text{ °C}$		
$I_{TSM}$	Non repetitive surge peak on-state current (full cycle sine wave, $T_j$ initial = $25\text{ °C}$ )	F = 60 Hz	t = 16.7 ms	13.7	A
		F = 50 Hz	t = 20 ms	13	
$I^2t$	$I^2t$ Value for fusing		$t_p = 10\text{ ms}$	1.1	$A^2s$
dI/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$ , $t_r \leq 100\text{ ns}$	F = 120 Hz	$T_j = 125\text{ °C}$	100	A/ $\mu s$
$V_{PP}$	Non repetitive mains peak mains voltage <sup>(1)</sup>			2	kV
$I_{GM}$	Peak gate current	$t_p = 20\text{ }\mu s$	$T_j = 125\text{ °C}$	1	A
$V_{GM}$	Peak positive gate voltage		$T_j = 125\text{ °C}$	10	V
$P_{G(AV)}$	Average gate power dissipation		$T_j = 125\text{ °C}$	0.1	W
$T_{stg}$ $T_j$	Storage junction temperature range Operating junction temperature range			-40 to +150 -30 to +125	$^{\circ}C$

1. According to test described by IEC 61000-4-5 standard and [Figure 18](#)

**Table 3. Electrical characteristics ( $T_j = 25\text{ °C}$ , unless otherwise specified)**

Symbol	Test conditions	Quadrant		Value	Unit
$I_{GT}^{(1)}$	$V_{OUT} = 12\text{ V}$ , $R_L = 33\text{ }\Omega$	II - III	Max.	10	mA
$V_{GT}$				1	V
$V_{GD}$	$V_{OUT} = V_{DRM}$ , $R_L = 3.3\text{ k}\Omega$ , $T_j = 125\text{ °C}$	II - III	Min.	0.15	V
$I_H$	$I_{OUT} = 100\text{ mA}$		Max.	10	mA
$I_L$	$I_G = 1.2 \times I_{GT}$		Max.	25	mA
dV/dt	$V_{OUT} = 402\text{ V}$ , gate open, $T_j = 125\text{ °C}$		Min.	2000	V/ $\mu s$
	$V_{OUT} = 536\text{ V}$ , gate open, $T_j = 125\text{ °C}$		Min.	400	V/ $\mu s$
(dI/dt)c	Without snubber (15 V/ $\mu s$ ), $T_j = 125\text{ °C}$ , turn-off time $\leq 20\text{ ms}$		Min.	2	A/ms
$V_{CL}$	$I_{CL} = 0.1\text{ mA}$ , $t_p = 1\text{ ms}$ , ACS108-6		Min.	650	V
	$I_{CL} = 0.1\text{ mA}$ , $t_p = 1\text{ ms}$ , ACS108-8		Min.	850	V

1. Minimum  $I_{GT}$  is guaranteed at 10% of  $I_{GT}$  max

**Table 4. Static electrical characteristics**

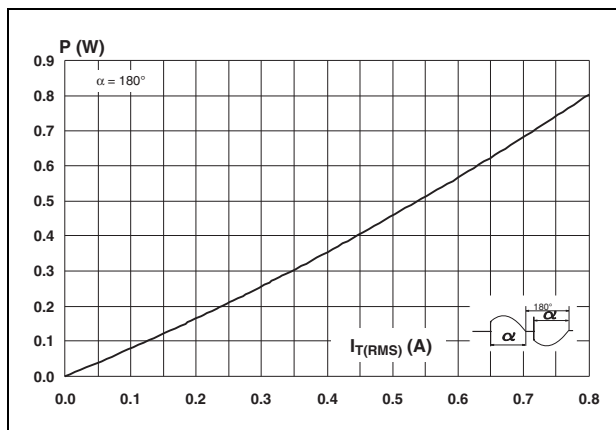
Symbol	Parameter and test conditions		Value	Unit	
$V_{TM}^{(1)}$	$I_{TM} = 1.1 \text{ A}$ , $t_p = 500 \mu\text{s}$	$T_j = 25 \text{ }^\circ\text{C}$	Max.	1.3	V
$V_{t0}^{(1)}$	Threshold voltage	$T_j = 125 \text{ }^\circ\text{C}$	Max.	0.85	V
$R_D^{(1)}$	Dynamic resistance	$T_j = 125 \text{ }^\circ\text{C}$	Max.	300	m $\Omega$
$I_{DRM}$ $I_{RRM}$	$V_{OUT} = V_{DRM} = V_{RRM}$	$T_j = 25 \text{ }^\circ\text{C}$	Max.	2	$\mu\text{A}$
		$T_j = 125 \text{ }^\circ\text{C}$		0.2	mA

1. For both polarities of OUT referenced to COM

**Table 5. Thermal resistance**

Symbol	Parameter		Value	Unit	
$R_{th(j-l)}$	Junction to lead (AC)	TO-92	Max.	60	$^\circ\text{C/W}$
$R_{th(j-t)}$	Junction to tab (AC)	SOT-223	Max.	25	
$R_{th(j-a)}$	Junction to ambient	TO-92	Max.	150	
		$S = 5 \text{ cm}^2$	SOT-223	Max.	

**Figure 2. Maximum power dissipation versus on-state rms current**



**Figure 3. On-state rms current versus case temperature (SOT223)**

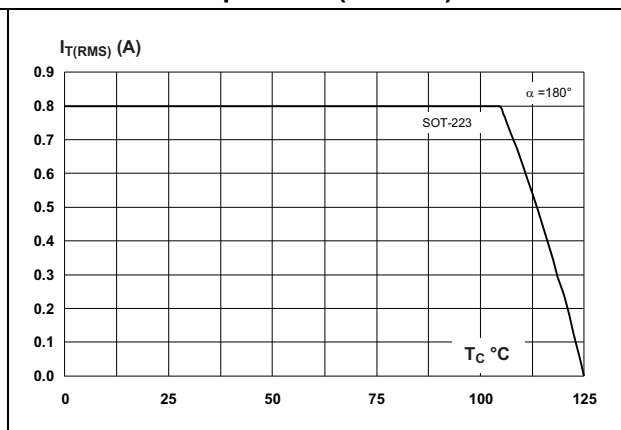


Figure 4. On-state rms current versus ambient temperature (free air convection)

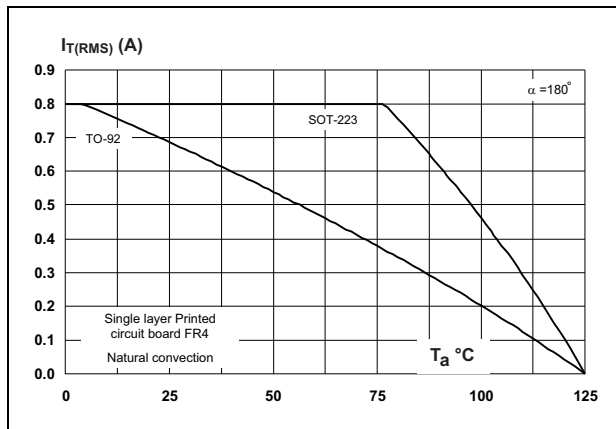


Figure 5. Relative variation of thermal impedance junction to ambient versus pulse duration

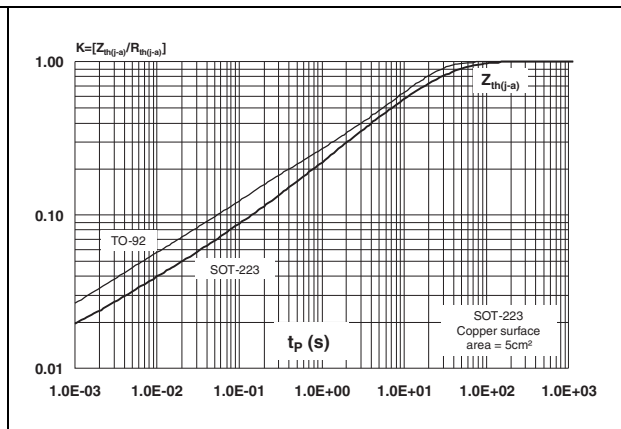


Figure 6. Relative variation of holding and latching current versus junction temperature

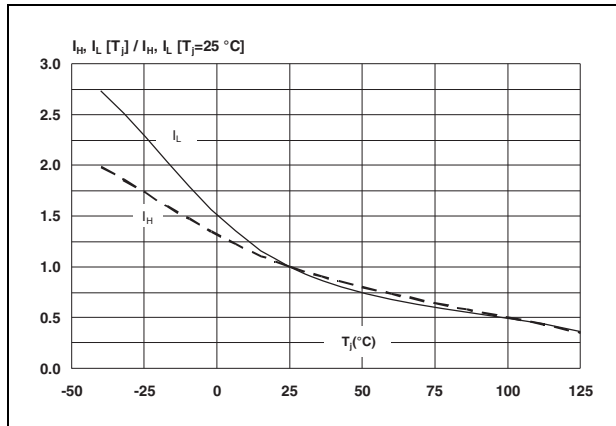


Figure 7. Relative variation of  $I_{GT}$  and  $V_{GT}$  versus junction temperature

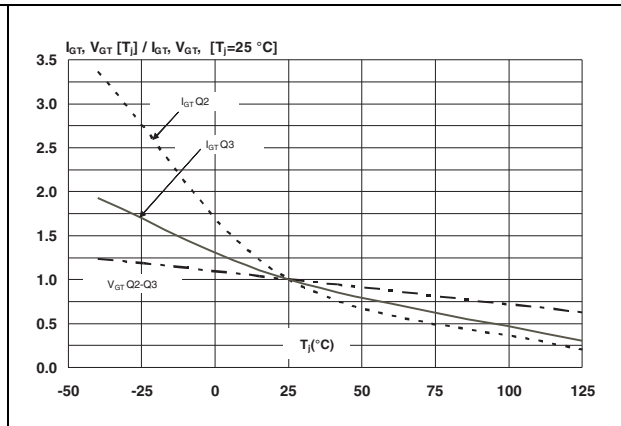


Figure 8. Surge peak on-state current versus number of cycles

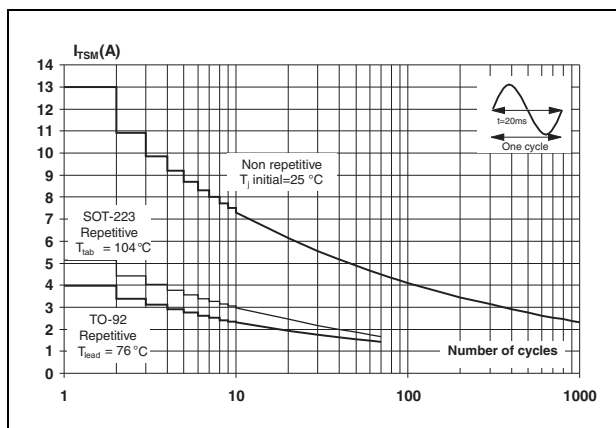


Figure 9. Non repetitive surge peak on-state current for a sinusoidal pulse, and corresponding value of  $I^2t$

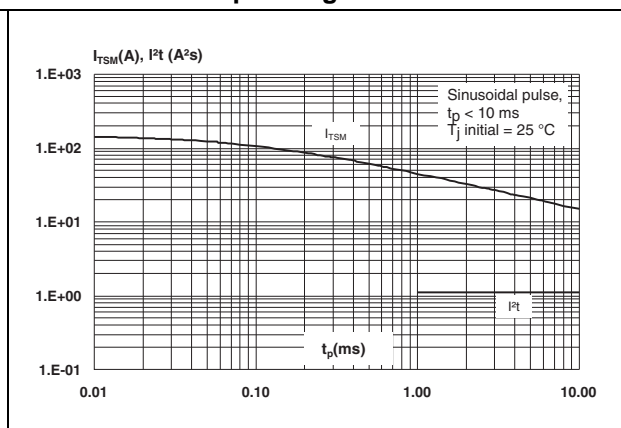


Figure 10. On-state characteristics (maximum values)

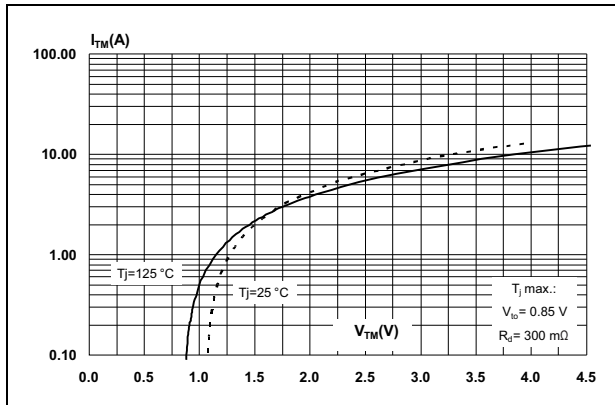


Figure 11. Relative variation of critical rate of decrease of main current versus junction temperature

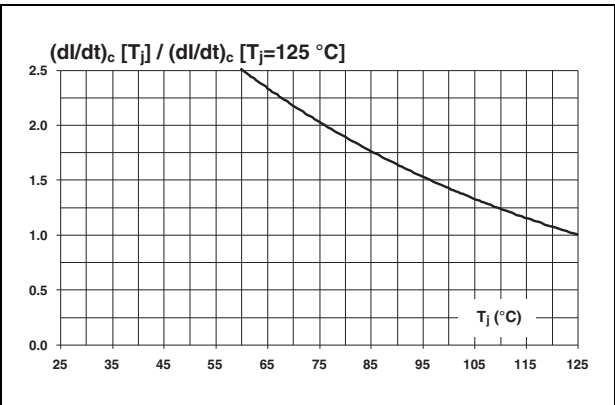


Figure 12. Relative variation of static dV/dt immunity versus junction temperature<sup>(1)</sup>

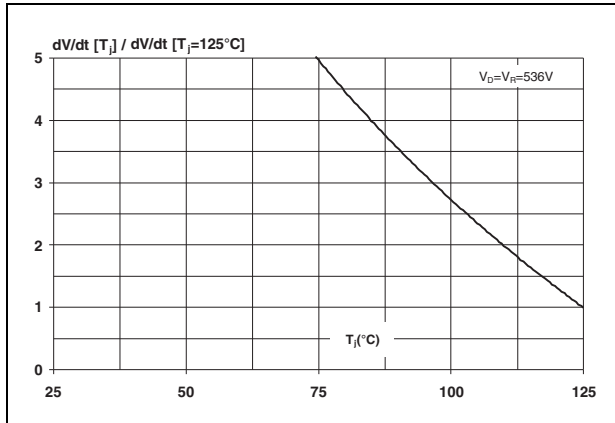
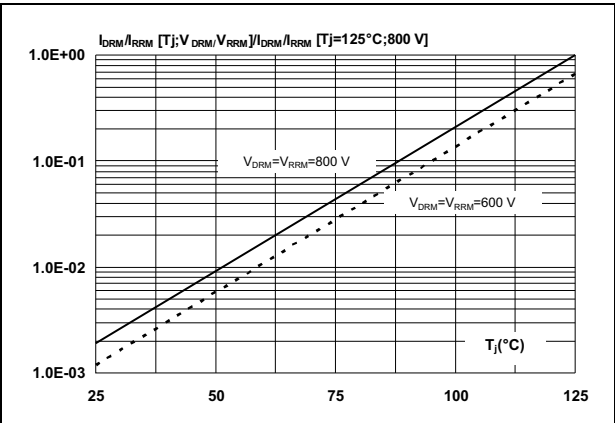


Figure 13. Relative variation of leakage current versus junction temperature



1.  $V_D = V_R = 402\text{ V}$ : Typical values above  $5\text{ kV}/\mu\text{s}$ . Beyond equipment capability

Figure 14. Relative variation of critical rate of decrease of main current  $(di/dt)_c$  versus  $(dV/dt)_c$

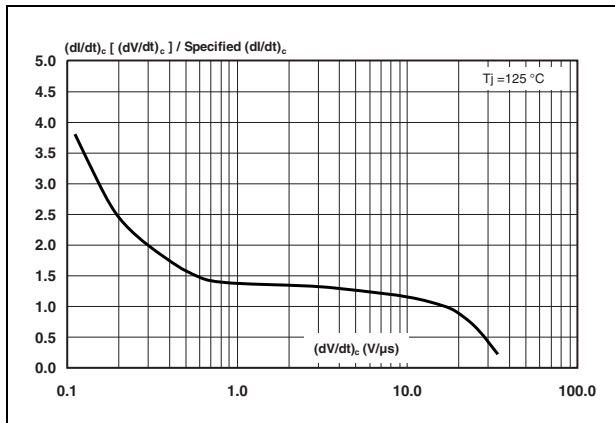
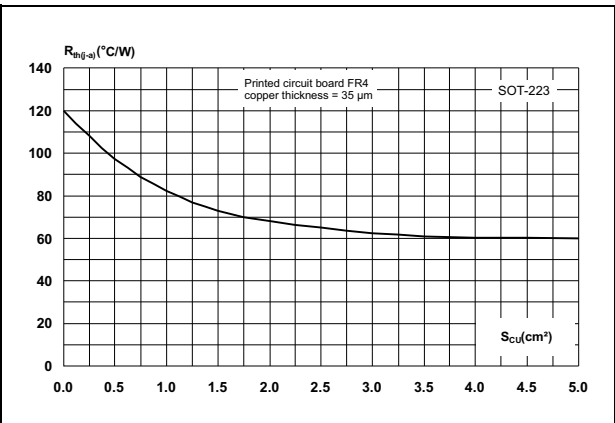


Figure 15. Thermal resistance junction to ambient versus copper surface under tab (SOT-223)

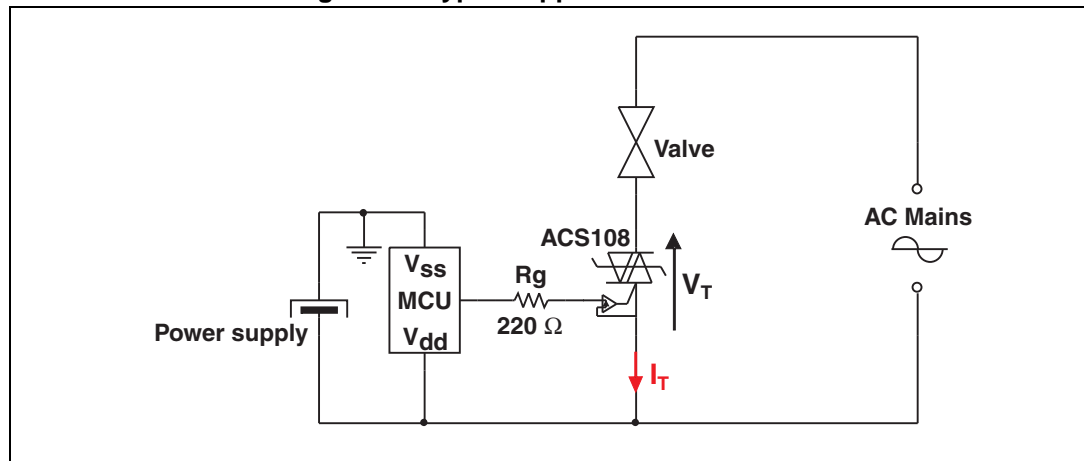


## 2 Alternating current mains switch - basic application

The ACS108 switch is triggered by a negative gate current flowing from the gate pin G. The switch can be driven directly by the digital controller through a resistor as shown in [Figure 16](#).

Thanks to its overvoltage protection and turn-off commutation performance, the ACS108 switch can drive a small power high inductive load with neither varistor nor additional turn-off snubber.

Figure 16. Typical application schematic



### 2.1 Protection against overvoltage: the best choice is ACS

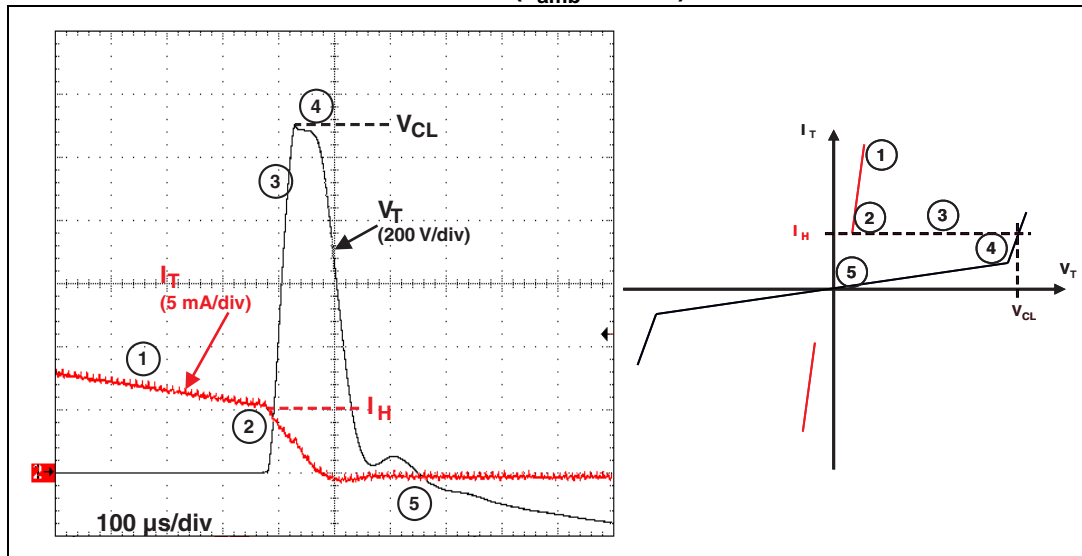
In comparison with standard Triacs the ACS108 is over-voltage self-protected, as specified by the new parameter  $V_{CL}$ . This feature is useful in two operating conditions: in case of turn-off of very inductive load, and in case of surge voltage that can occur on the electrical network.

#### 2.1.1 High inductive load switch-off: turn-off overvoltage clamping

With high inductive and low rms current loads the rate of decrease of the current is very low. An overvoltage can occur when the gate current is removed and the OUT current is lower than  $I_H$ .

As shown in [Figure 17](#), at the end of the last conduction half-cycle, the load current decreases ①. The load current reaches the holding current level  $I_H$  ②, and the ACS turns off ③. The water valve, as an inductive load (up to 15 H), reacts as a current generator and an overvoltage is created, which is clamped by the ACS ④. The current flows through the ACS avalanche and decreases linearly to zero. During this time, the voltage across the switch is limited to the clamping voltage  $V_{CL}$ . The energy stored in the inductance of the load is dissipated in the clamping section that is designed for this purpose. When the energy has been dissipated, the ACS voltage falls back to the mains voltage value (230 V rms, 50 Hz) ⑤.

Figure 17. Switching off of a high inductive load - typical clamping capability of ACS108 ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ )



### 2.1.2 Alternating current mains transient voltage ruggedness

The ACS108 switch is able to withstand safely the AC mains transients either by clamping the low energy spikes or by breaking-over when subjected to high energy shocks, even with high turn-on current rises.

The test circuit shown in *Figure 18* is representative of the final ACS108 application, and is also used to test the AC switch according to the IEC 61000-4-5 standard conditions. Thanks to the load limiting the current, the ACS108 switch withstands the voltage spikes up to 2 kV above the peak mains voltage. The protection is based on an overvoltage crowbar technology. Actually, the ACS108 breaks over safely as shown in *Figure 19*. The ACS108 recovers its blocking voltage capability after the surge (switch off back at the next zero crossing of the current).

Such non-repetitive tests can be done 10 times on each AC mains voltage polarity.

Figure 18. Overvoltage ruggedness test circuit for resistive and inductive loads,  $T_{amb} = 25\text{ }^{\circ}\text{C}$  (conditions equivalent to IEC 61000-4-5 standard)

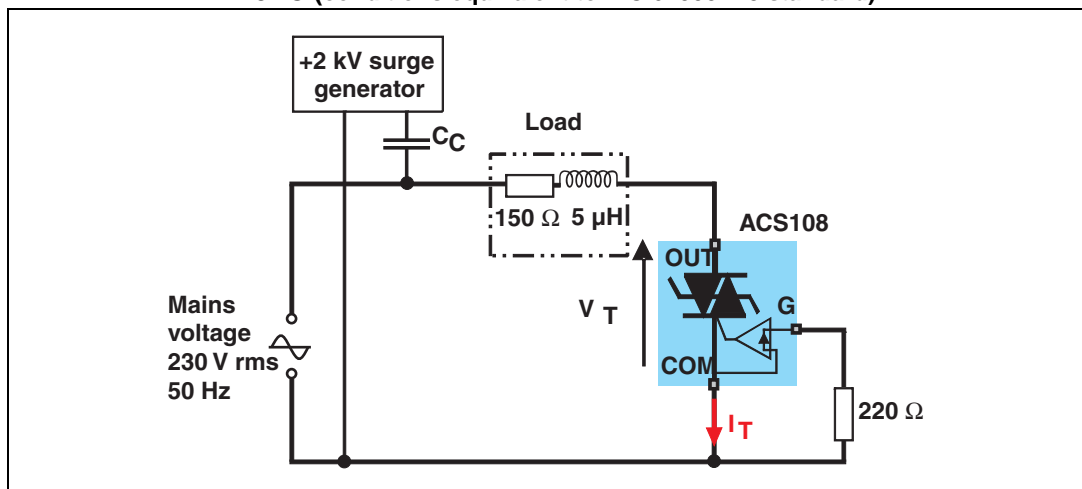
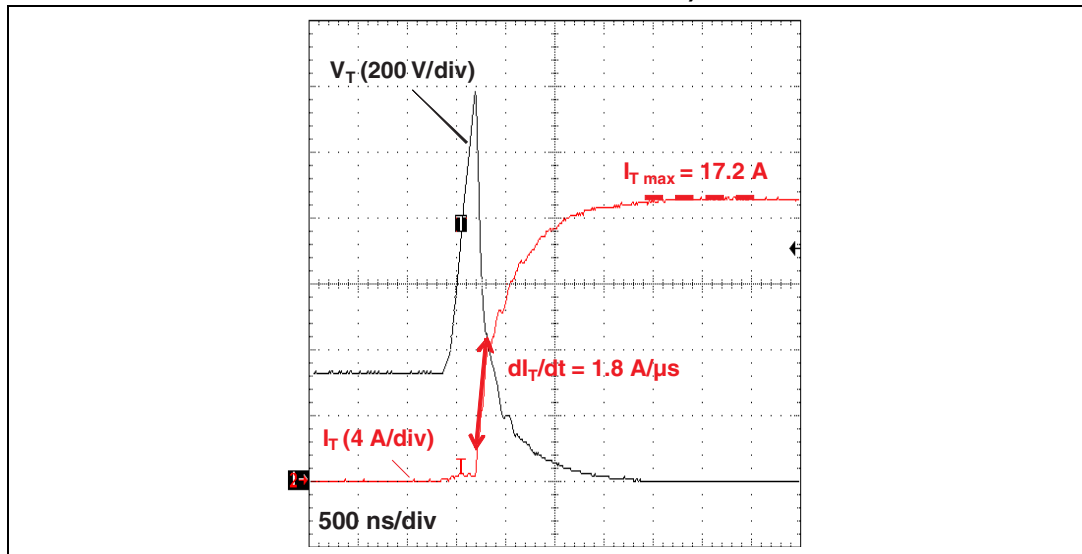


Figure 19. Typical current and voltage waveforms across the ACS108 (+2 kV surge, IEC 61000-4-5 standard)





### 3 Package information

- Epoxy meets UL94, V0
- Lead-free packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

Figure 20. TO-92 dimension definitions

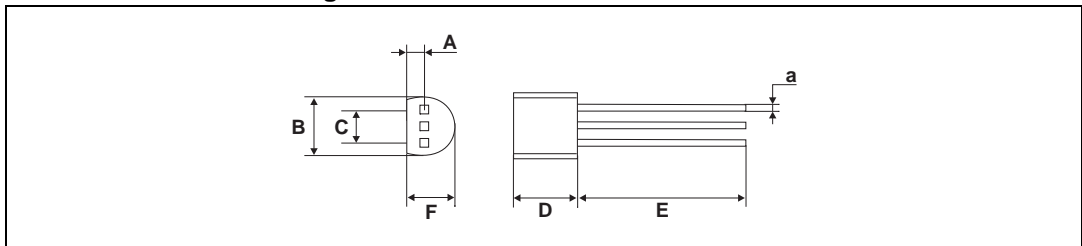


Table 6. TO-92 dimension values

Ref	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A		1.35			0.053	
B			4.70			0.185
C		2.54			0.100	
D	4.40			0.173		
E	12.70			0.500		
F			3.70			0.146
a			0.50			0.019

Figure 21. SOT-223 dimension definitions

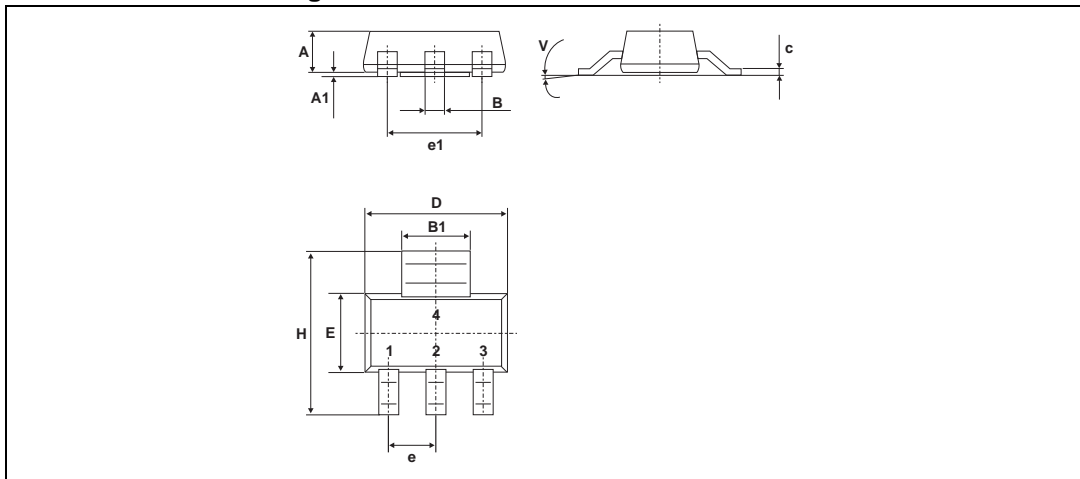
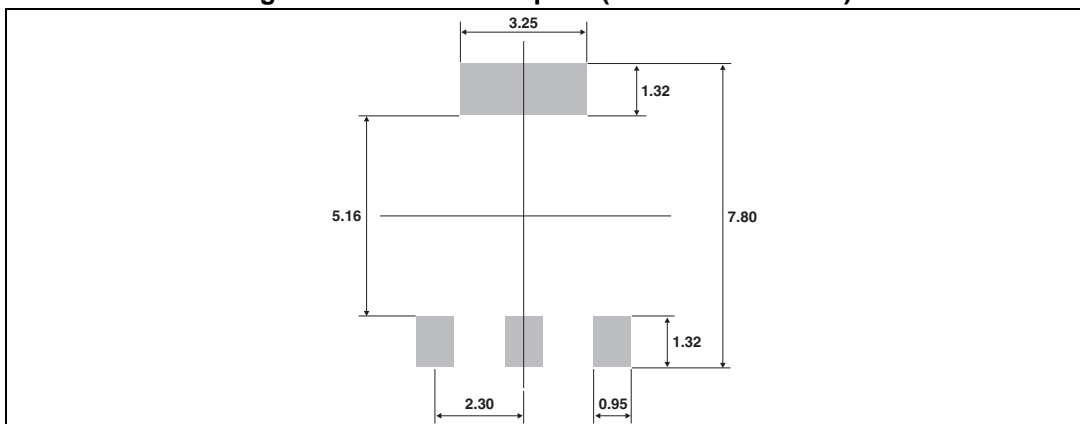


Table 7. SOT-223 dimension values

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.80			0.071
A1		0.02	0.10		0.001	0.004
B	0.60	0.70	0.85	0.024	0.027	0.033
B1	2.90	3.00	3.15	0.114	0.118	0.124
c	0.24	0.26	0.35	0.009	0.010	0.014
D <sup>(1)</sup>	6.30	6.50	6.70	0.248	0.256	0.264
e		2.3			0.090	
e1		4.6			0.181	
E <sup>(1)</sup>	3.30	3.50	3.70	0.130	0.138	0.146
H	6.70	7.00	7.30	0.264	0.276	0.287
V	10° max					

1. Do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm (0.006inches)

Figure 22. SOT-223 footprint (dimensions in mm)



## 4 Ordering information

Figure 23. Ordering information scheme

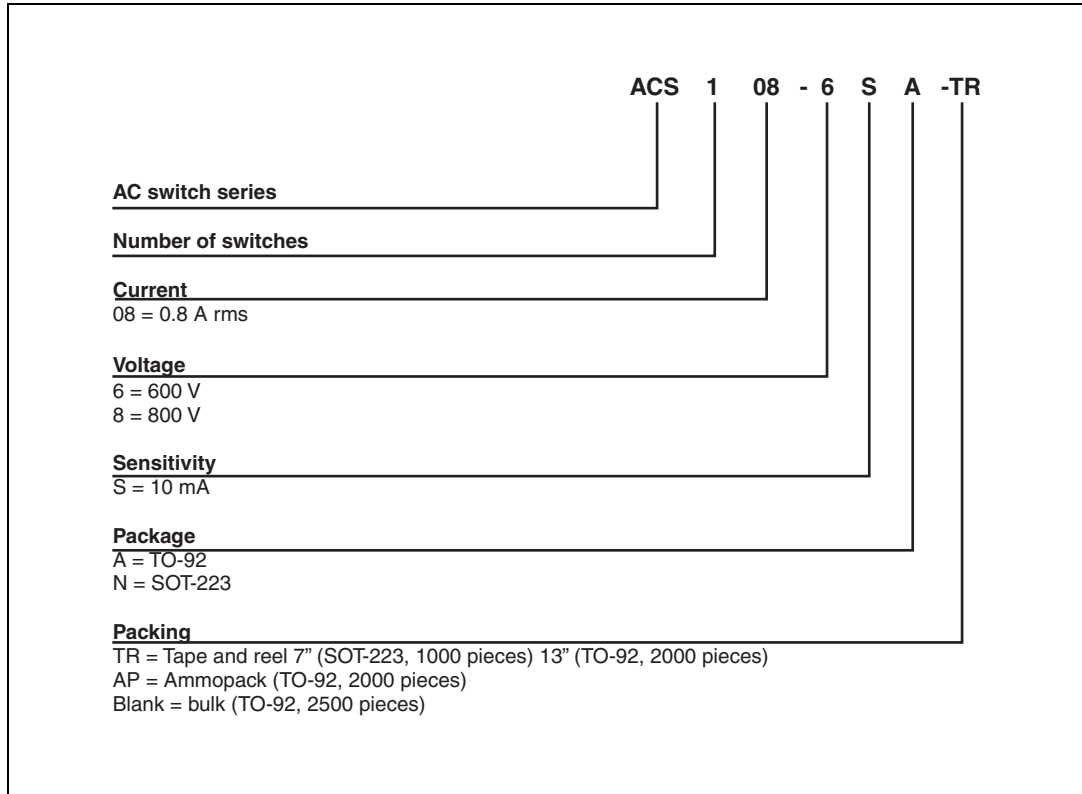


Table 8. Ordering information

Order code	Marking	Package	Weight	Base Qty	Delivery mode
ACS108-6SA	ACS1 086SA	TO-92	0.2 g	2500	Bulk
ACS108-6SA-TR		TO-92	0.2 g	2000	Tape and reel
ACS108-6SA-AP		TO-92	0.2 g	2000	Ammopack
ACS108-6SN-TR	ACS 108 6SN	SOT-223	0.11 g	1000	Tape and reel
ACS108-8SA	ACS1 088SA	TO-92	0.2 g	2500	Bulk
ACS108-8SA-TR		TO-92	0.2 g	2000	Tape and reel
ACS108-8SA-AP		TO-92	0.2 g	2000	Ammopack
ACS108-8SN-TR	ACS 108 8SN	SOT-223	0.11 g	1000	Tape and reel

## 5 Revision history

**Table 9. Document revision history**

Date	Revision	Changes
Apr_2004	1	Initial release. This datasheet covers order codes previously described in the datasheet for ACS108-6S, Doc ID 11962, Rev 3 December 2010.
21-Jun-2005	2	Marking information updated from ACSxxxx to ACS1xxx.
11-Jul-2012	3	Removed 500 V devices and added 600 V and 800 V devices.
27-Sep-2013	4	Corrected typographical error in <a href="#">Figure 4</a> .
31-Oct-2013	5	Corrected character formatting issues in <a href="#">Section 2.1.1</a> .

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